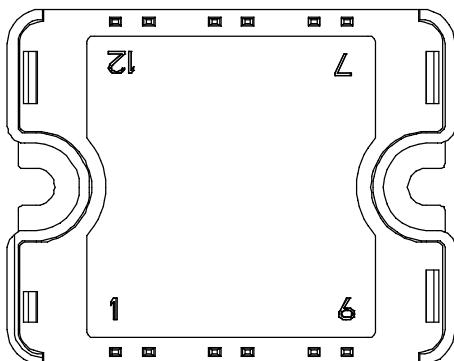
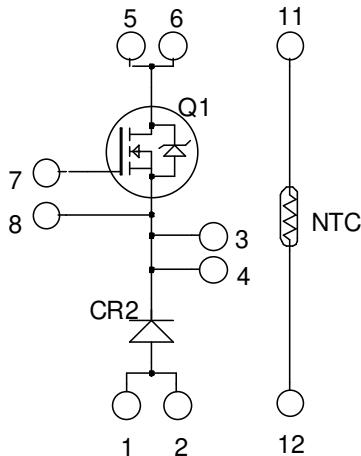


**Buck chopper  
MOSFET Power Module**

**V<sub>DSS</sub> = 1200V**  
**R<sub>DSon</sub> = 680mΩ typ @ T<sub>j</sub> = 25°C**  
**I<sub>D</sub> = 15A @ T<sub>c</sub> = 25°C**



Pins 1/2 ; 3/4 ; 5/6 must be shorted together

**Absolute maximum ratings**

| Symbol            | Parameter   | Max ratings           | Unit |
|-------------------|---|-----------------------|------|
| V <sub>DSS</sub>  | Drain - Source Breakdown Voltage                  | 1200                  | V    |
| I <sub>D</sub>    | Continuous Drain Current                          | T <sub>c</sub> = 25°C | A    |
|                   |   | T <sub>c</sub> = 80°C |      |
| I <sub>DM</sub>   | Pulsed Drain current                              | 90                    |      |
| V <sub>GS</sub>   | Gate - Source Voltage                             | ±30                   | V    |
| R <sub>DSon</sub> | Drain - Source ON Resistance                      | 816                   | mΩ   |
| P <sub>D</sub>    | Maximum Power Dissipation                         | T <sub>c</sub> = 25°C | W    |
| I <sub>AR</sub>   | Avalanche current (repetitive and non repetitive) | 12                    | A    |

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

| Symbol       | Characteristic                  | Test Conditions                                 |                           | Min | Typ | Max       | Unit             |
|--------------|---------------------------------|---|---------------------------|-----|-----|-----------|------------------|
| $I_{DSS}$    | Zero Gate Voltage Drain Current | $V_{DS} = 1200\text{V}$<br>$V_{GS} = 0\text{V}$ | $T_j = 25^\circ\text{C}$  |     |     | 100       | $\mu\text{A}$    |
|              |                                 |   | $T_j = 125^\circ\text{C}$ |     |     | 500       |                  |
| $R_{DS(on)}$ | Drain – Source on Resistance    | $V_{GS} = 10\text{V}$ , $I_D = 12\text{A}$      |                           |     | 680 | 816       | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage          | $V_{GS} = V_{DS}$ , $I_D = 2.5\text{mA}$        |                           | 3   | 4   | 5         | $\text{V}$       |
| $I_{GSS}$    | Gate – Source Leakage Current   | $V_{GS} = \pm 30\text{ V}$                      |                           |     |     | $\pm 100$ | $\text{nA}$      |

**Dynamic Characteristics**

| Symbol       | Characteristic               | Test Conditions  |  | Min | Typ  | Max | Unit        |
|--------------|------------------------------|--|--|-----|------|-----|-------------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0\text{V}$<br>$V_{DS} = 25\text{V}$<br>$f = 1\text{MHz}$     |  |     | 6696 |     | $\text{pF}$ |
| $C_{oss}$    | Output Capacitance           |  |  |     | 615  |     |             |
| $C_{rss}$    | Reverse Transfer Capacitance |  |  |     | 80   |     |             |
| $Q_g$        | Total gate Charge            | $V_{GS} = 10\text{V}$<br>$V_{Bus} = 600\text{V}$<br>$I_D = 12\text{A}$ |  |     | 260  |     | $\text{nC}$ |
| $Q_{gs}$     | Gate – Source Charge         |  |  |     | 42   |     |             |
| $Q_{gd}$     | Gate – Drain Charge          |  |  |     | 120  |     |             |
| $T_{d(on)}$  | Turn-on Delay Time           |  | <b>Resistive switching @ <math>25^\circ\text{C}</math></b> |     | 45   |     | $\text{ns}$ |
| $T_r$        | Rise Time                    | $V_{GS} = 15\text{V}$<br>$V_{Bus} = 800\text{V}$<br>$I_D = 12\text{A}$ |  |     | 27   |     |             |
| $T_{d(off)}$ | Turn-off Delay Time          |  |  |     | 145  |     |             |
| $T_f$        | Fall Time                    |  |  |     | 42   |     |             |

**Chopper diode ratings and characteristics**

| Symbol    | Characteristic                          | Test Conditions  |                           | Min  | Typ  | Max | Unit          |  |
|-----------|---|--|---------------------------|------|------|-----|---------------|--|
| $V_{RRM}$ | Maximum Peak Repetitive Reverse Voltage | $V_R = 1200\text{V}$   |                           | 1200 |      |     | $\text{V}$    |  |
| $I_{RM}$  | Maximum Reverse Leakage Current         |  | $T_j = 25^\circ\text{C}$  |      |      | 100 | $\mu\text{A}$ |  |
| $I_F$     | DC Forward Current                      |  | $T_c = 80^\circ\text{C}$  |      | 30   |     | $\text{A}$    |  |
| $V_F$     | Diode Forward Voltage                   | $I_F = 30\text{A}$   |                           |      | 2.6  | 3.1 | $\text{V}$    |  |
|           |   | $I_F = 60\text{A}$   |                           |      | 3.2  |     |               |  |
|           |   | $I_F = 30\text{A}$   | $T_j = 125^\circ\text{C}$ |      | 1.8  |     |               |  |
| $t_{rr}$  | Reverse Recovery Time                   | $I_F = 30\text{A}$<br>$V_R = 800\text{V}$<br>$di/dt = 200\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$  |      | 300  |     | $\text{ns}$   |  |
|           |   |  | $T_j = 125^\circ\text{C}$ |      | 380  |     |               |  |
| $Q_{rr}$  | Reverse Recovery Charge                 |  | $T_j = 25^\circ\text{C}$  |      | 360  |     | $\text{nC}$   |  |
|           |   |  | $T_j = 125^\circ\text{C}$ |      | 1700 |     |               |  |

**Thermal and package characteristics**

| Symbol     | Characteristic   |             | Transistor | Min  | Typ | Max  | Unit                      |
|------------|--|-------------|------------|------|-----|------|---------------------------|
| $R_{thJC}$ | Junction to Case Thermal Resistance  |             | Diode      |      |     | 0.35 | $^\circ\text{C}/\text{W}$ |
|            |  |             |            |      |     | 1.2  |                           |
| $V_{ISOL}$ | RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1\text{mA}$ , 50/60Hz |             |            | 2500 |     |      | $\text{V}$                |
| $T_j$      | Operating junction temperature range   |             |            | -40  |     | 150  | $^\circ\text{C}$          |
| $T_{STG}$  | Storage Temperature Range  |             |            | -40  |     | 125  |                           |
| $T_c$      | Operating Case Temperature   |             |            | -40  |     | 100  |                           |
| Torque     | Mounting torque  | To heatsink | M4         | 2.5  |     | 4.7  | $\text{N.m}$              |
| Wt         | Package Weight   |             |            |      |     | 80   | $\text{g}$                |

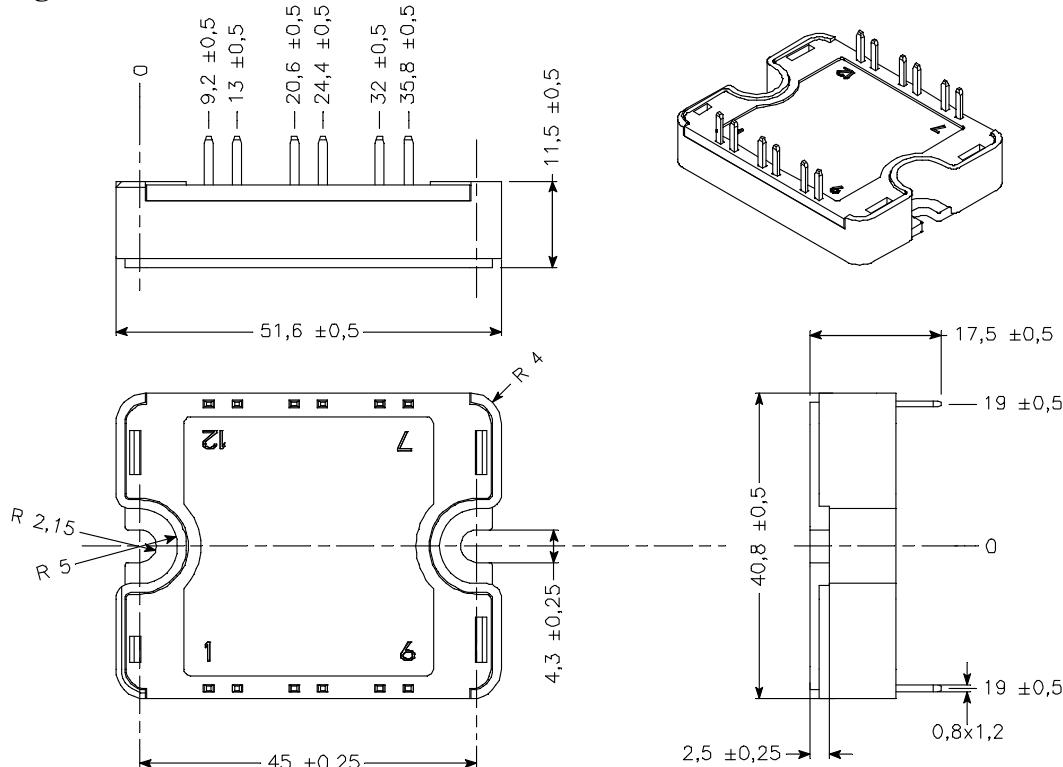
**Temperature sensor NTC** (see application note APT0406 on [www.microsemi.com](http://www.microsemi.com) for more information).

| Symbol             | Characteristic             | Min | Typ  | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R <sub>25</sub>    | Resistance @ 25°C          |     | 50   |     | kΩ   |
| B <sub>25/85</sub> | T <sub>25</sub> = 298.15 K |     | 3952 |     | K    |

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

T: Thermistor temperature  
R<sub>T</sub>: Thermistor value at T

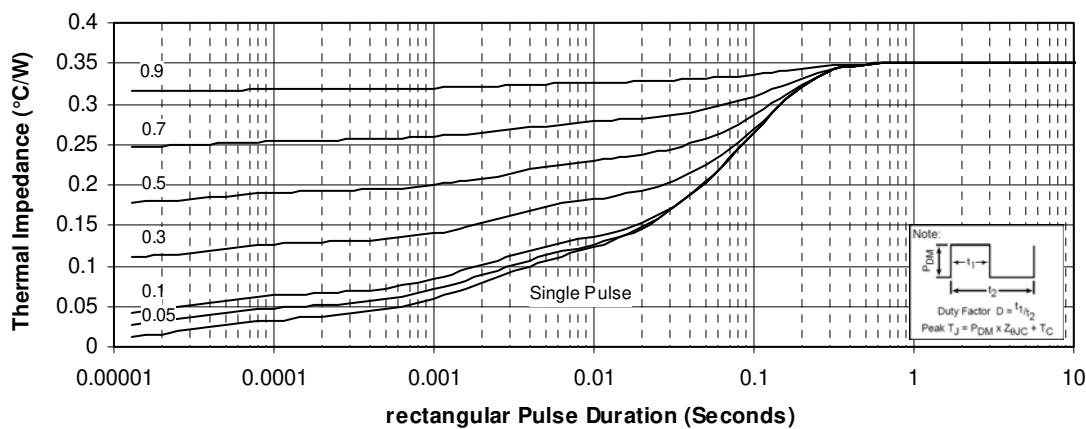
### SP1 Package outline (dimensions in mm)

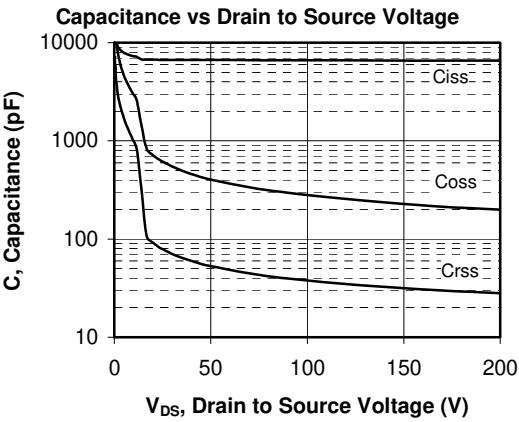
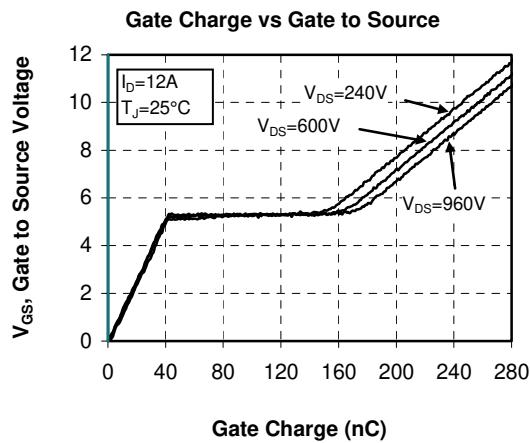
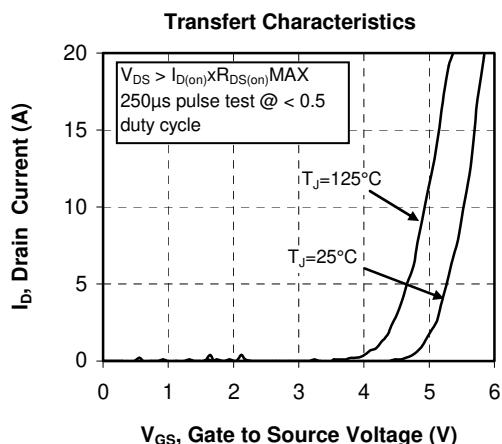
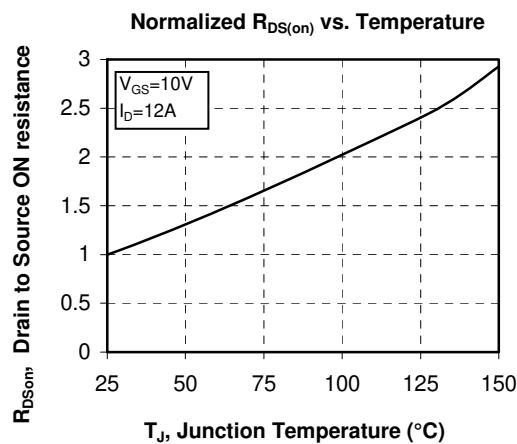
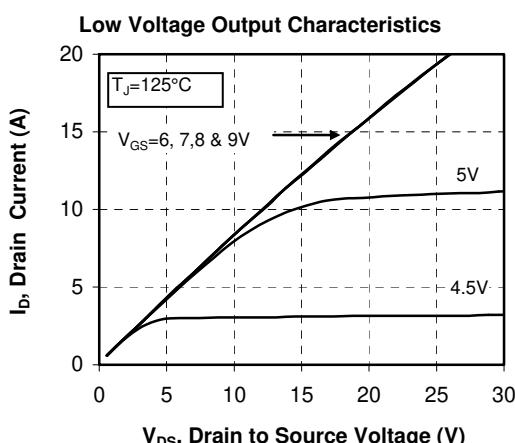
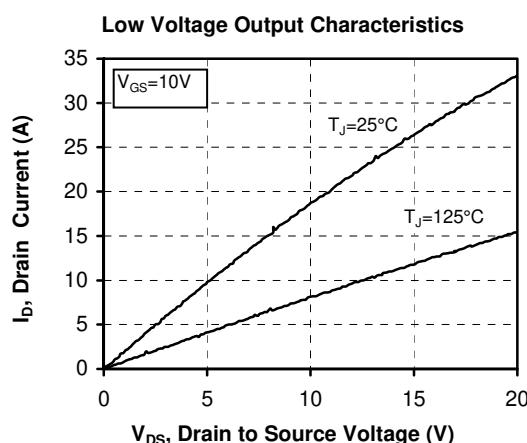


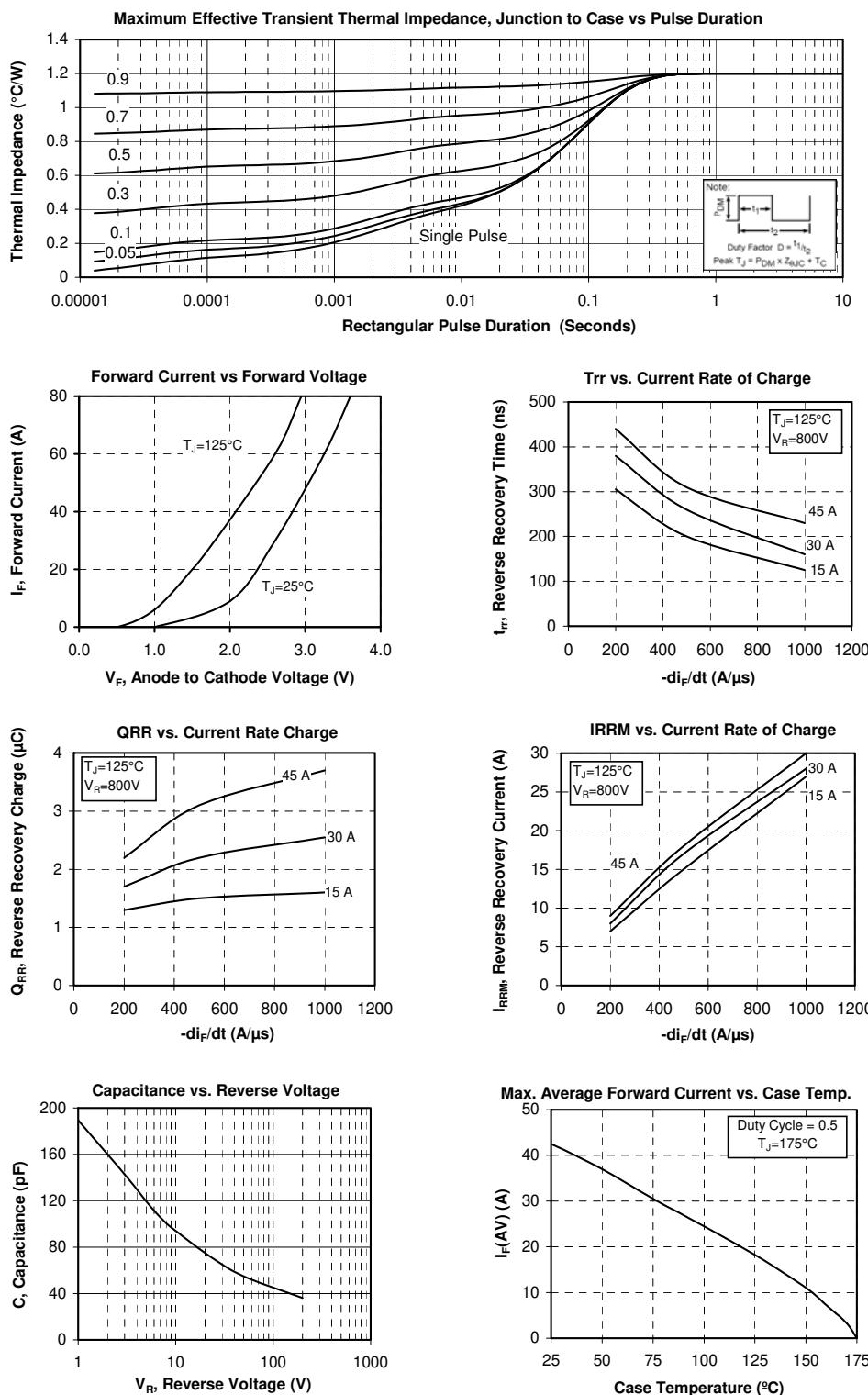
See application note 1904 - Mounting Instructions for SP1 Power Modules on [www.microsemi.com](http://www.microsemi.com)

### Typical Mosfet Performance Curve

Maximum Effective Transient Thermal Impedance, Junction to Case vs Pulse Duration





**Typical Diode Performance Curve**


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